



eGuard0524P TVS Arrays

Description - eGuard™

The eGuard0524P* is an ultra low capacitance TVS (Transient Voltage Suppressor) array designed to protect sensitive semiconductor components from electrical overstress when interfaced to high-speed data lines. The ultra low capacitance (0.35pF typical I/O to I/O) of the eGuard0524P ensures negligible signal attenuation at data rates up to 3.5GHz. The solid-state construction ensures fast clamping of electrical overstress transients resulting from ESD (electrostatic discharge), EFT (Electrical Fast Transients) or CDE (Cable Discharge Events).

In addition to ultra low capacitance, the eGuard0524P provides superior surge current capability and excellent voltage clamping performance. The surge current capability (8x20µs) is rated at 7A; approximately 33% higher than industry norms. Furthermore, the tight clamping ratio (VC/VRWM) of 1.9 (typical at 1A) ensures harmful transients are clamped quickly and close to the normal working voltage of the circuit. The super tight clamping ratio is 30% better than industry norms and ensures superior protection of sensitive integrated circuits.

The eGuard0524P is designed to protect up to four data lines. It is packaged in a RoHS/WEEE compliant, 10 pin DFN that has a very low package profile of 0.5mm (nominal). The combination of ultra low capacitance, high surge capability, tight clamping ratio and low package profile make the eGuard0524P the ideal choice for today's ESD sensitive, space constrained applications.

Features

- ESD protection in accordance with: IEC 61000-4-2 (ESD) ±17kV (air), ±12kV (contact) IEC 61000-4-5 (lightning) 7A (8/20µs) IEC 61000-4-4 (EFT) 40A (5/50ns)
- Tight clamping ratio, VC/VRWM, ensures superior protection
- High reverse surge current, IPP, capability
- Low idle current minimizes standby power consumption
- Low profile DFN package
- Package design optimized for high speed lines
- Flow-Through design
- Protects four I/O lines
- Low capacitance: 0.35pF typical (I/O to I/O)
- Low operating voltage: 5V
- Solid-state silicon-avalanche technology

Pin Configuration

10	9	8	7	6		
U	Ü		U	U		
	\cap	()	\cap	()		
1	2	3	4	5		

Pin	Identification
1, 2, 4, 5	Input Lines
6, 7, 9, 10	Output Lines (No Internal Connection)
3, 8	Ground

Mechanical Characteristics

- DFNWB2.5×1-10L 10-pin package
- RoHS/WEEE Compliant
- Lead Pitch: 0.5mm
- Lead finish: Pure Sn
- Marking: Marking Code
- Packaging: Tape and Reel

Applications

- High Definition Multi-Media Interface (HDMI)
- Digital Visual Interface (DVI)
- DisplayPort TM Interface
- MDDI(Mobile Display Digital Interface)Ports
- PCI(Peripheral Component Interconnect) Express
- eSATA(External Serial Advanced Technology Attachment)Interfaces

Circuit Diagram



* The eGuard logo is a trademark of SMC Diode Solutions - Sangdest Microelectronics (Nanjing) Co.

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eGuard0524P



Ordering Information

Device	Package	Shipping	
eGuard0524P	DFNWB2.5×1-10L (Pb-Free)	3000pcs / reel	

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Maximum Ratings @T_A=25°C unless otherwise specified

Parameter	Symbol	Value	Units
Peak Pulse Current (tp=8/20µs)	I PP	7	А
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	Vesd	±17 ±12	kV
Operating Junction Temperature Range	TJ	-55 to + 150	°C
Storage Temperature Range	Tstg	-55 to + 150	°C

Electrical Characteristics

Characteristics	Symbol	Condition	Min.	Тур.	Max.	Units
Reverse Stand-Off Voltage	V _{RWM}	Any I/O pin to ground	-	-	5	V
Reverse Breakdown Voltage	V_{BR}	@ I _t =1mA Any I/O pin to ground	6	-	-	V
Forward Voltage Drop	VF	@ I _F =1mA, T = 25 ℃	-	-	0.9	V
Reverse Leakage Current	I _R	@V _{RWM} = 5V, T = 25 ℃ Any I/O pin to ground	-	0.5	1	μA
Clamping Voltage	Vc	@I _{PP} = 1A, tp=8/20µs Any I/O pin to ground	-	9.5	10.5	V
Clamping Voltage	Vc	@I _{PP} = 7A, tp=8/20µs Any I/O pin to ground	-	-	17	V
Junction Capacitance	Cj	@V _R = 0V, f _{SIG} = 1MHz Between I/O pins	-	0.35	0.4	pF
Junction Capacitance	Cj	@V _R = 0V, f _{SIG} = 1MHz Any I/O pin to ground	-	0.65	0.8	pF

 $^{*}\,$ Pulse width < 300 $\mu s,\,$ duty cycle < 2%



eGuard0524P



Ratings and Characteristics Curves





Fig.2 Pulse Waveform



Fig. 3 Clamping Voltage vs. Peak Pulse Current

Fig. 4 Normalized Capacitance vs. Reverse Voltage













Fig. 6 USB3.0 Eye Diagram



eGuard0524P



Part Name Information



Marking Diagram

Where 524P is eGuard0524P

Х

524P X

524P = Part name = Marking code for date code

Cautions: Molding resin Epoxy resin UL:94V-0

Mechanical Dimensions DFNWB2.5×1-10L



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Soldering Pad Layout (Millimeters)



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Data Sheet N1680 REV.C





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